

GSM1336TF

100V N-Channel MOSFET

Product Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

The device is well suited for high efficiency fast switching applications.

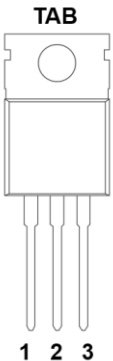
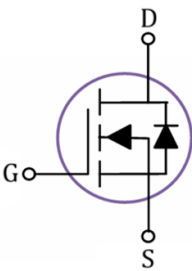
Features

- $R_{DS(ON)} = 3.8m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} = 5.4m\Omega @ V_{GS}=4.5V$
- TO-220-3L Package
- RoHS Compliant and Halogen Free

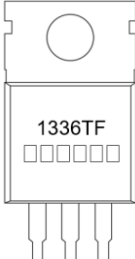
Applications

- MB / VGA / Vcore
- POL Applications
- SMPS

Packages & Pin Assignments

TO-220-3L			Equivalent Circuit		
					
Pin	Symbol	Description	Pin	Symbol	Description
1	G	Gate	2	D	Drain
3	S	Source	TAB	D	Drain

Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Tube
GSM1336TF	TO-220-3L	1336TF □□□□□□	50 PCS
GSM1336 1 2			
<div> <div>- Product Code: GSM1336</div> <div>- Package Code: 1 is T for TO-220-3L</div> <div>- Green Level: 2 is F for RoHS Compliant and Halogen Free</div> </div>			
Marking Information			
<div>  <div> <div>- Product Code: 1336TF</div> <div>- GS Code: □□□□□□</div> </div> </div>			

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{DSS}	Drain-Source Voltage		100	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Continuous Drain Current (Silicon Limited)	T _C =25°C	165	A
		T _C =100°C	104	
	Continuous Drain Current (Package Limited)		120	
I _{DM}	Pulsed Drain Current ¹		400	A
I _{AS}	Single Pulse Avalanche Current, L = 0.1mH ¹		34	A
E _{AS}	Single Pulse Avalanche Energy, L = 0.1mH ¹		115	mJ
P _D	Power Dissipation	T _C =25°C	208	W
		T _C =100°C	83	
R _{θJC}	Thermal Resistance-Junction to Case		0.6	°C/W
R _{θJA}	Thermal Resistance-Junction to Ambient ²		62	°C/W
T _J	Operating Junction Temperature Range		-55 to +150	°C
T _{STG}	Storage Temperature Range		-55 to +150	°C

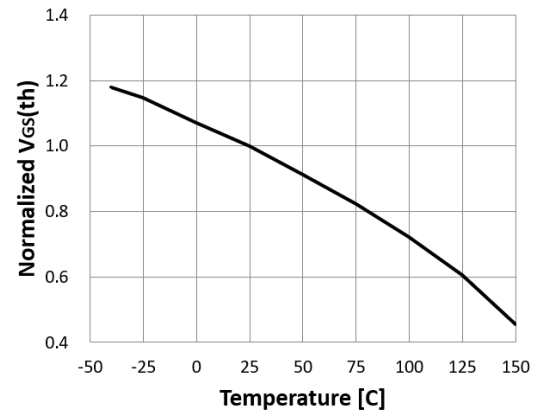
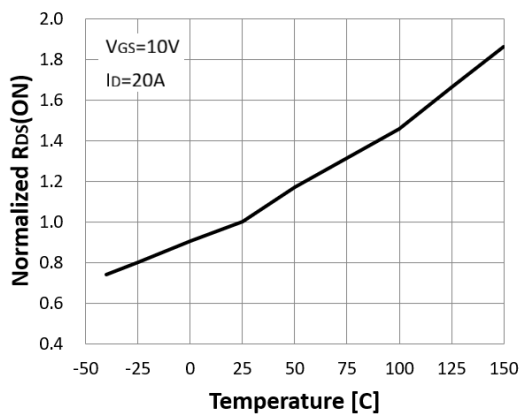
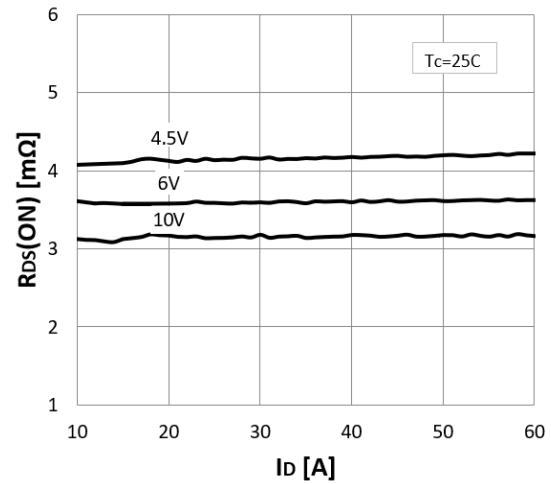
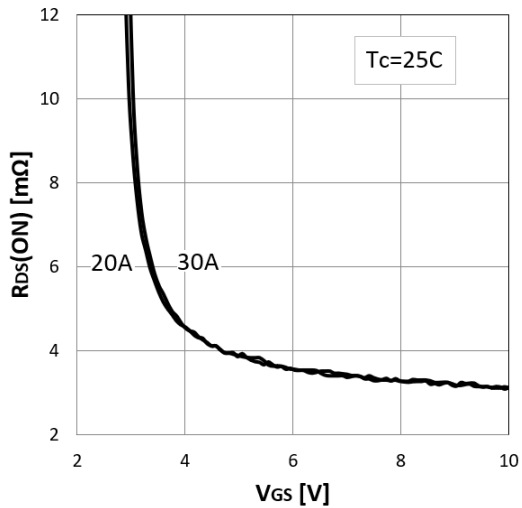
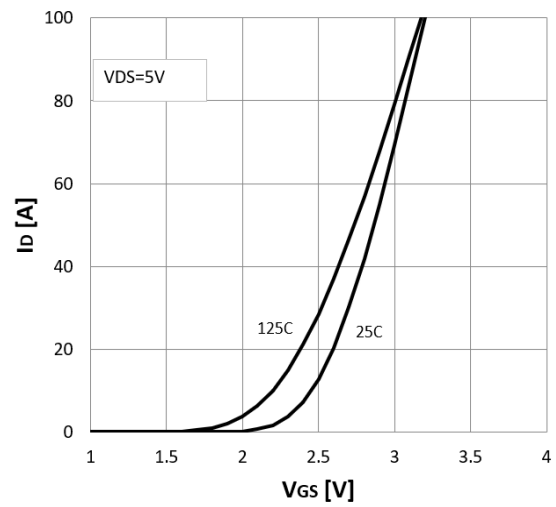
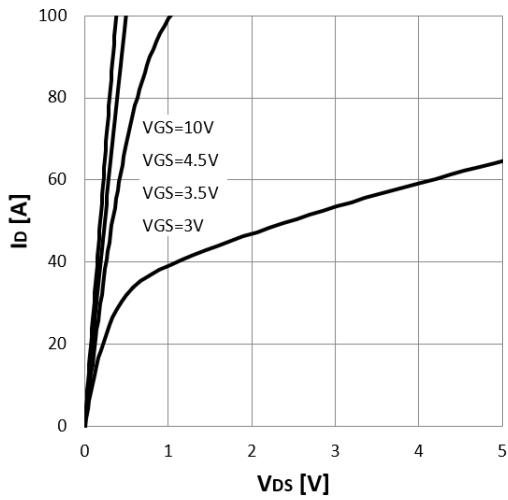
NOTE:

1. Single pulse width is limited by max junction temperature.

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.2	-	2.5	V
R _{DS(ON)}	Drain-Source On-Resistance	V _{GS} =10V, I _D =20A	-	3.3	3.8	mΩ
		V _{GS} =4.5V, I _D =15A	-	4.6	5.4	
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A	-	60	-	S
Dynamic Characteristics						
R _g	Gate Resistance	f=1MHz		0.9		Ω
C _{iSS}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, f=1MHz	-	4020	-	pF
C _{oSS}	Output Capacitance		-	970	-	
C _{rSS}	Reverse Transfer Capacitance		-	36	-	
Q _g	Total Gate Charge	V _{DS} =50V, I _D =20A V _{GS} =10V	-	95	-	nC
Q _{gs}	Gate-Source Charge		-	10	-	
Q _{gd}	Gate-Drain Charge		-	32	-	
t _{d(on)}	Turn-On Delay Time	V _{DD} =50V, I _D =20A V _{GS} =10V, R _g =6Ω	-	38	-	ns
t _r	Turn-On Rise Time		-	60	-	
t _{d(off)}	Turn-Off Delay Time		-	57	-	
t _f	Turn-Off Fall Time		-	20	-	
Diode Characteristics						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1A	-	-	1	V
t _{rr}	Reverse Recovery Time	I _F =50A , dI/dt=100A/μs	-	76	-	ns
Q _{rr}	Reverse Recovery Charge		-	210	-	nC

Typical Performance Characteristics



Typical Performance Characteristics

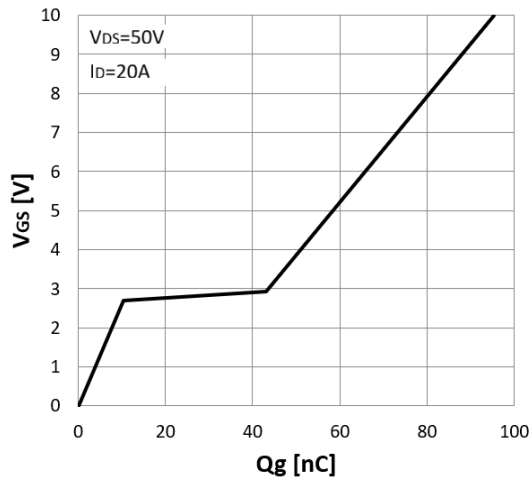


Fig.7 Gate Charge Characteristics

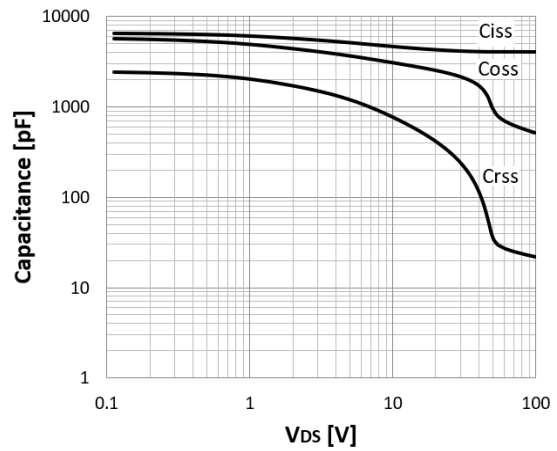


Fig.8 Capacitance Characteristics

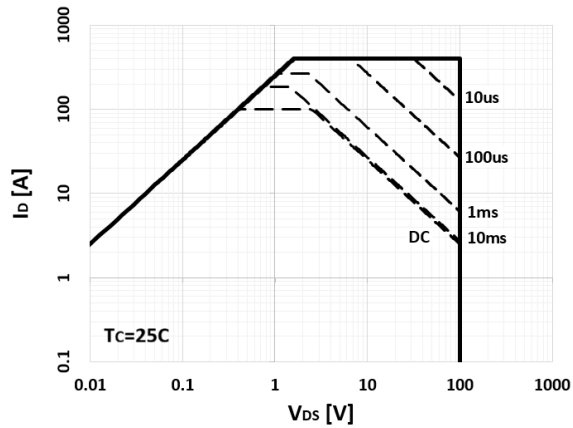


Fig.9 Maximum Safe Operation Area

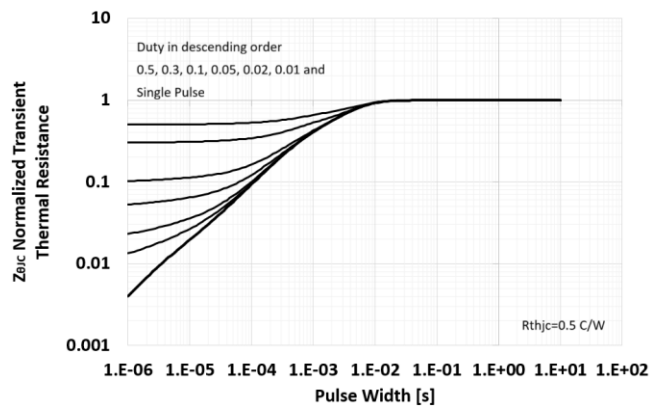
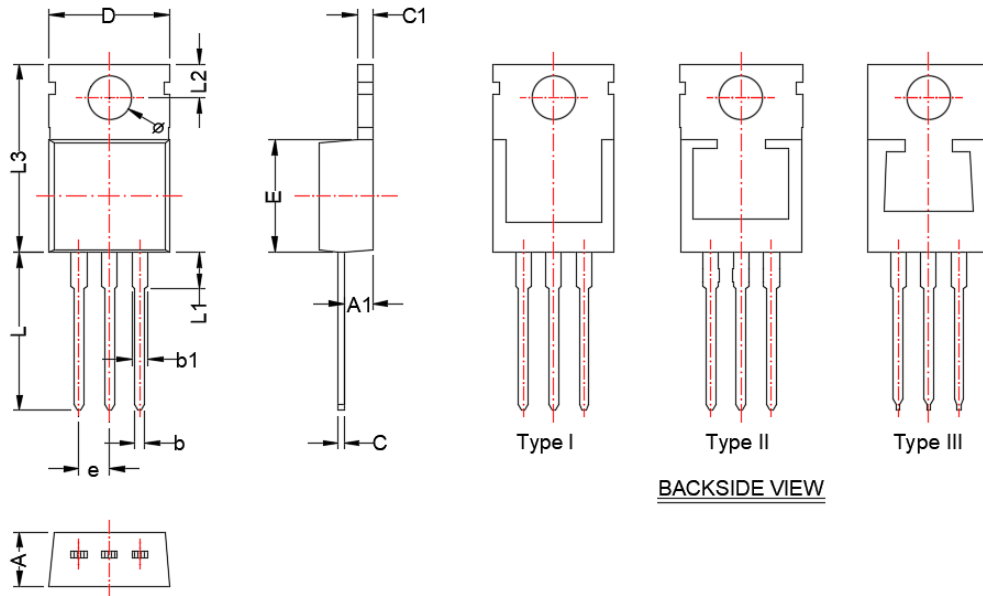


Fig.10 Normalized Transient Impedance

TO-220-3L

Package Dimension







Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	3.56	4.82	0.140	0.190
A1	2.03	2.92	0.080	0.115
b	0.38	1.14	0.015	0.045
b1	1.00	1.78	0.039	0.070
c	0.30	1.14	0.012	0.045
c1	0.51	1.50	0.020	0.059
D	9.50	10.67	0.374	0.420
E	8.38	9.42	0.330	0.371
e	2.54 BSC		0.100 BSC	
L	12.00	14.73	0.472	0.250
L1	---	7.00	---	0.250
L2	2.54	3.43	0.100	0.135
L3	14.22	16.51	0.560	0.650
Ø	3.40	4.09	0.134	0.161



NOTE:
Dimensions are exclusive of Burrs, Mold Flash and Tie Bar extrusions.

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